

STBLEMesh Android application and STSW-BNRG-Mesh solution: potential reflection and replay risk in certain authentication modes

Overview:

This security advisory describes a potential risk related to reflection and replay scenarios during provisioning or authentication when certain authentication modes are used in:

1. The STBLEMesh Android application,
2. The STSW-BNRG-Mesh software solution,
3. Custom applications developed using the BlueNRG-Mesh Android SDK.

The risk may arise in specific configurations and usage scenarios.

Affected products:

Product	Version	Type	Note
STBLEMesh Android application	STBLEMesh V1.17 and below versions	Android application	-
STSW-BNRG-Mesh	1.13.001 and below versions	Software solution for BLE Mesh	-
BlueNRG-Mesh Android SDK	1.15.000 and below versions	Software SDK	BlueNRG-Mesh Android SDK is part of STSW-BNRG-Mesh

STBLEMesh Android application:

- Open the side menu and navigate to "About".
- If the version number is 1.17 or below, the application may be affected.

Custom Android applications built with BlueNRG-Mesh Android SDK:

- Check the release notes of the BlueNRG-Mesh SDK used to build the application.
- If the SDK version is 1.15 or below, the application may be affected.

Description:

In certain authentication modes, reflection and replay scenarios may arise during the provisioning and authentication process. The described scenarios are associated with provisioning interactions and may require proximity and active participation in the provisioning process.

In some circumstances, these scenarios could affect the intended authentication behavior, including assumptions regarding proof of knowledge of the AuthValue.

For more details, refer to the Bluetooth SIG guidance:

<https://www.bluetooth.com/learn-about-bluetooth/key-attributes/bluetooth-security/impersonation-mesh/>

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Impact:

If exploited under certain conditions, this risk could affect provisioning or authentication behavior and may allow an unauthorized party to obtain the NetKey and join the mesh network.

Remediation:

1. For users of the STBLEMesh Android application from Google play:
 - Update to version 1.18 or later, which includes updates intended to mitigate the risk described in this advisory.
2. For developers using STSW-BNRG-Mesh (BlueNRG-Mesh Android SDK):
 - Rebuild and release applications using STSW-BNRG-Mesh version 1.14 or later, the corresponding BlueNRG-Mesh Android SDK version is 1.16.000 or later.
3. If an immediate update is not feasible:
 - Consider restricting use of the following authentication modes in affected deployments where possible:
 - No OOB
 - Static OOB

Credit:

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Revision history

Table 1. Document revision history

Date	Revision	Changes
09-Jun-2026	1	Initial release.

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